

Lessons and Recommendations for Board Level Testing with Protons

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Acronyms

DUT	Device Under Test
ISS	International Space Station
JPL	Jet Propulsion Laboratory
LEO	Low Earth Orbit
LET	Linear Energy Transfer
MeV	million electron-Volts
MOSFET	Metal Oxide Semiconductor Field Effect Transistor
NASA	National Aeronautics and Space Administration
NEPP	NASA Electronic Parts and Packaging Program
SEE	Single-Event Effects
SEL	Single-Event Latchup
TID	Total Ionizing Dose
TRIUMF	Tri-University Meson Facility
UUT	Unit Under Test
Vgs	gate-to-source Voltage



Outline

- **What is board-level testing with protons**
- **What are the potential problems**
- **It has be useful... why?**
- **Test planning**
- **Test preparation**
- **Test execution**
- **Test interpretation**
- **Lessons Learned (note, not in paper)**
- **Summary**



Board Level Testing Done Right

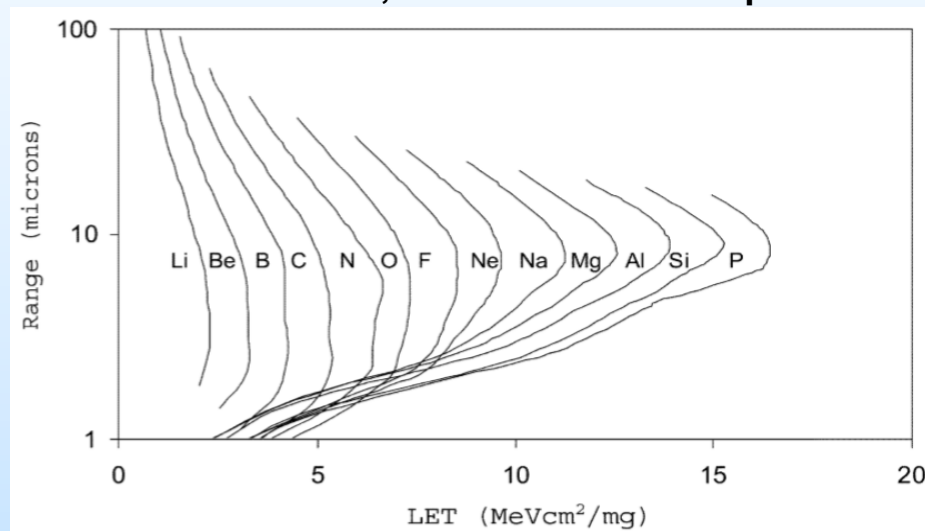
- **Is there a simple and cheap way to do single-event effects testing of a board, all at once?**
 - It depends...
- **If you have the right combination of**
 - Mild environment
 - Short duration
 - Willingness to accept risk
- **What do you do?**
 - Test with high (~ 200 MeV) protons. (Next slide...)
- **How good is it?**
 - Questionable – worse if done wrong. (Rest of the talk.)



Why 200 MeV?

- Protons are a proxy for heavy ions because their secondaries give LETs in excess 14 MeV-cm²/mg.
- The higher the energy of the beam, the higher the energy (not LET) of the secondaries.
 - Total deposited energy is higher, so they are more space-like.
- Higher energy is better.
 - Increased range improves damaging SEE effectiveness
 - Higher LETs in space are mostly Fe – missing in proton secondaries...
- But higher energy is not readily available, and doesn't really improve things much.
 - Max LET is still only around 14 MeV-cm²/mg
 - Overall range is better
 - Options like Los Alamos (800 MeV) and TRIUMF (500 MeV) exist.

Heimstra, 2003 – for 500 MeV protons





200 MeV Is a Sweet-Spot, but...

- It is good for proton secondaries.
- Higher proton energy also reduces dose.
- It puts SEE test facilities in-line with medical facilities.

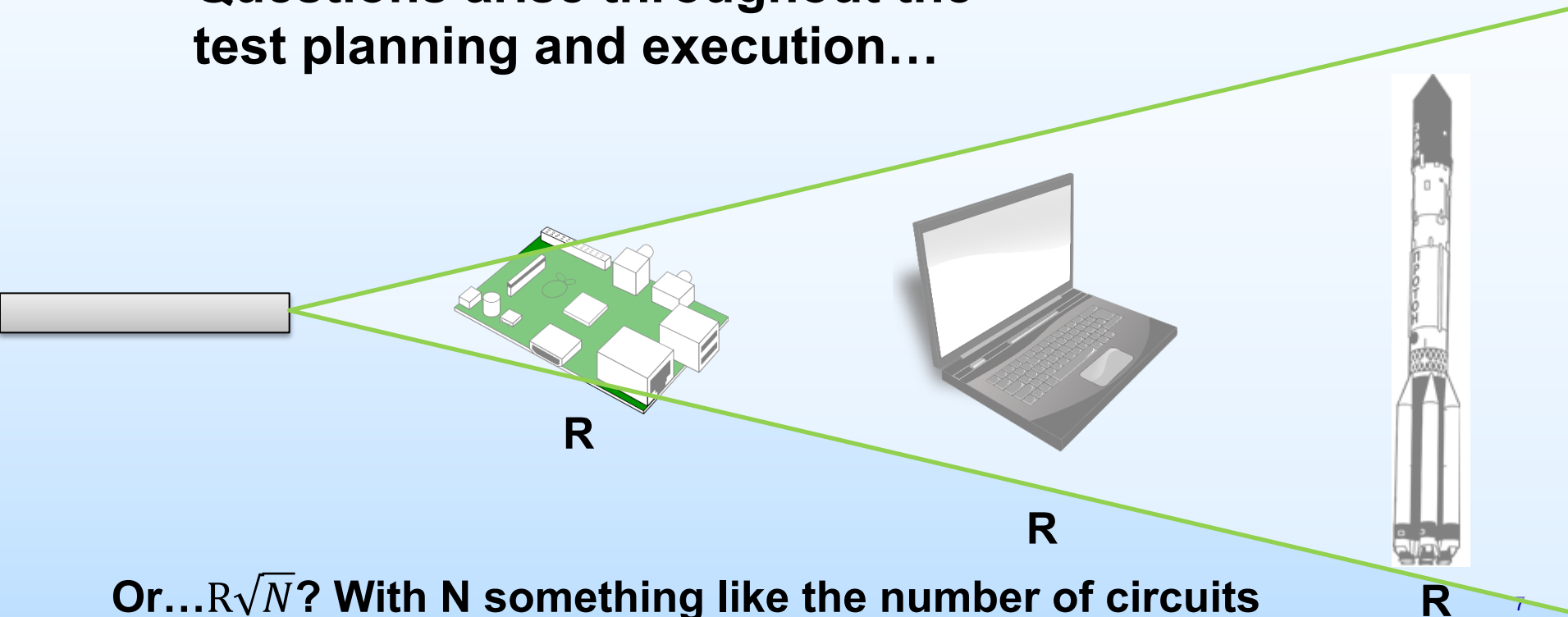


- Dozens of facilities...



There Are Many Potential Issues

- Test results are not well-defined, because system size can be arbitrary
 - Assume the test results in a system rate of R ...
- Questions arise throughout the test planning and execution...



Or... $R\sqrt{N}$? With N something like the number of circuits



Scorecard



- The proton board-level testing method has a history of success
- But it is not supported by solid engineering or physics
- Have previous practitioners have been conservative in using the approach?
 - Maybe
- Have we been lucky that systems worked well?
 - Probably. Might even be “accidentally” mitigating damage
 - NASA has only used this in non-critical systems
- Have some failures not been reported?
 - Difficult to say on the NASA side – probably logged, but not necessarily brought to attention of radiation people
 - Suspect situation is worse in most other organizations



Moving Forward

- **Approach is driven by data on worst parts – is there really enough data yet? Most likely no.**
 - **Why would anyone take proton data on a part that is observed to have SEL with an LET of less than 10?**
 - **Why take heavy ion data in a part has SEL with protons?**
- **Given the inherent limitations of the method, how can we achieve the best results?**
- **We will explore some specific situations and a couple lessons learned.**



Test Planning

- You can only reliably achieve 0.01-0.003 damaging events per system day in LEO – if this is not good enough, heavy ions are required.
 - Higher assurance claims are not grounded in physics or engineering, but may “seem” to work.
 - Test early in the cycle, so the results can be used. Don’t just hope the results will be ok.
 - Test the same board as the flight board – same parts – manufacturer and part number should match.
 - “good engineering” says they really need to be the same, but people are often trying to justify “similar devices”
 - Reserve beam time 8 months ahead of time. Proton beam time is difficult to schedule.
- A horizontal bar containing five icons: an envelope, a calendar, a group of people, a clipboard with a checkmark, and three dots.
- Use beam energy of at least 190 MeV in order to keep TID on articles below 1 krad(Si) when irradiating to $1 \times 10^{10}/\text{cm}^2$.



Test Preparation

- **Contact facility to get details and recommendations for use of the facility.**
- **If possible, perform a walkthrough of the facility a few weeks before the actual test.**
- **Discuss beam parameters with the facility: time and space structure, flux & flux range, etc.**
- **Determine if the facility can accommodate the full size of your hardware.**
- **Hardware usually cannot ship for at least a few days after the test.**
- **Test the full setup (including full cable length) before arriving at the facility.**
- **More info in the paper.**

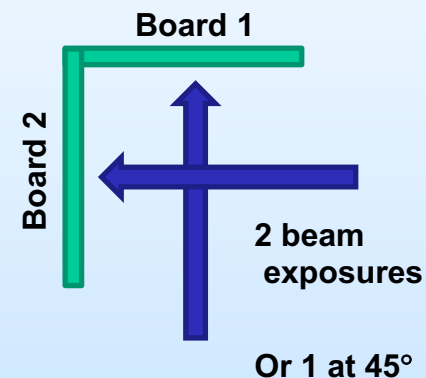
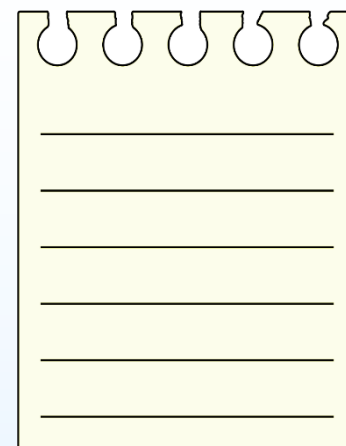


Photo: Irradiation of iPad at UC Davis – due to spot size, multiple irradiation sites were necessary.



Test Execution

- **Keep a test log including:**
 - run number
 - DUT/UUT identification
 - time, fluence, flux
 - etc...
- **Use cooling fans instead of heatsinks (keep fans out of beam) – if possible**
- **Avoid stacks of 6 or more boards**
- **Test with proton beam normal to the test boards**
 - If boards are mounted 90 degrees to each other, test multiple units with beam normal to the board surfaces
 - If angles are used, multiply the fluence delivered by the cosine of the angle of incidence.
- **Use beam exposures with duration > 60 s, with at least 10 s between events, or consider slowing down the beam.**



**More in
the paper**



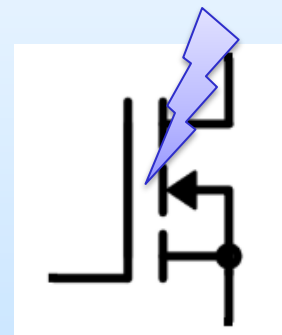
Test Interpretation/Reporting

- It would be great to have a detailed test report, but a simple summary of the test and observations should be a minimum
- If damaging events are **NOT SEEN**, use the following estimations:
 - 0.01 events/system-day for $1 \times 10^{10}/\text{cm}^2$ or
 - 0.003 events/system-day for $1 \times 10^{11}/\text{cm}^2$
- For non-damaging events (transients, bit upsets, etc.)
 - $N * 0.0005$ events/system-day for $1 \times 10^{10}/\text{cm}^2$ where N is the number of observed events.
 - This scales for higher test fluences.
- If damaging events are seen, use the larger of estimates above.



Lesson: Be Ready to Use Test Results

- During one board level test, a permanent failure was observed.
- Because the schematics were available, and a radiation expert (familiar with parts list reviews) was on hand...
 - A list of at-risk parts was identified
 - List was narrowed down by circuit implementation
 - Further narrowed down by failure (no power delivered)
- Identified a MOSFET operating at $>80\%$ of rated V_{gs} in the design
 - Recommendation is $< 50\%$
 - Circuit testing showed the MOSFET had failed
- Were able to swap in alternate (with higher V_{gs}) that enabled system to work and not fail in radiation.





Lesson Learned: Flight-Like Operation

- **Test approach was to have all board operations cycled through during exposure**
 - Complex applications made to target all board operations – multiple applications
- **The board was dependent on a commercial PowerPC processor running Linux, with the operations in a test program.**
- **Actual observations were primarily kernel panics due to unhandled exceptions.**
 - No value was obtained from different software applications
- **None of the special test applications showed SEEs because operating system was primary weak point.**
- **Lesson: Don't develop a lot of extra test operations outside of flight use**



Photo: Efika 400MHz PowerPC SBC



Summary

- **Proton testing can be used in lieu of normal assurance (including heavy ions) if**
 - Environment is weak (i.e. LEO, ISS, Mars Surface)
 - Missing is short or can handle high risk
- **Physics and engineering both suggest fairly high rates for possible damaging SEE**
 - 0.01 to 0.003/system-day for ISS orbit when testing with 1×10^{10} - $1 \times 10^{11}/\text{cm}^2$.
- **To ensure the test method provides results that can be trusted to these levels, we provide recommendations.**
 - Test Planning
 - Test Preparation
 - Test Execution
 - Text Interpretation/Analysis